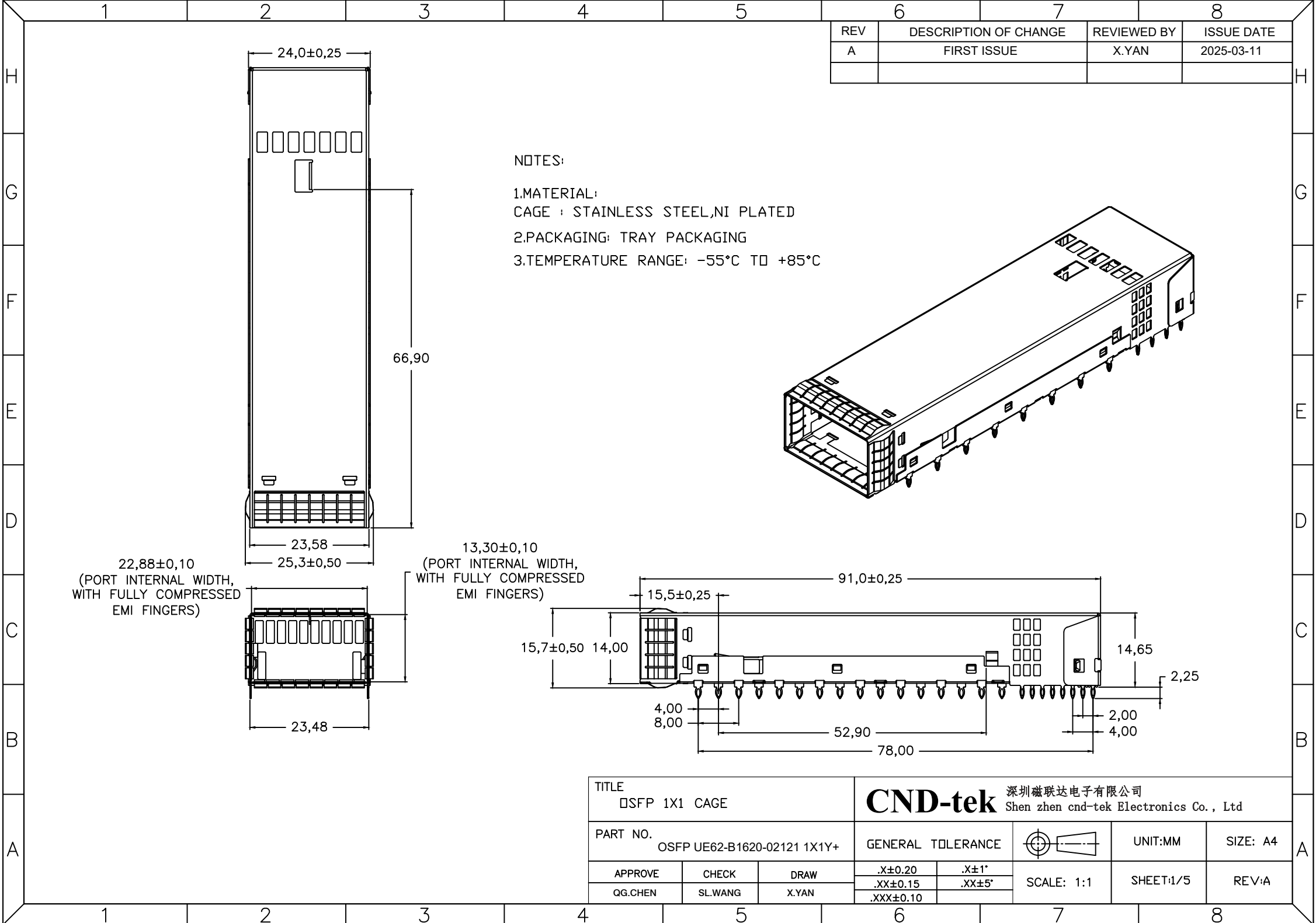
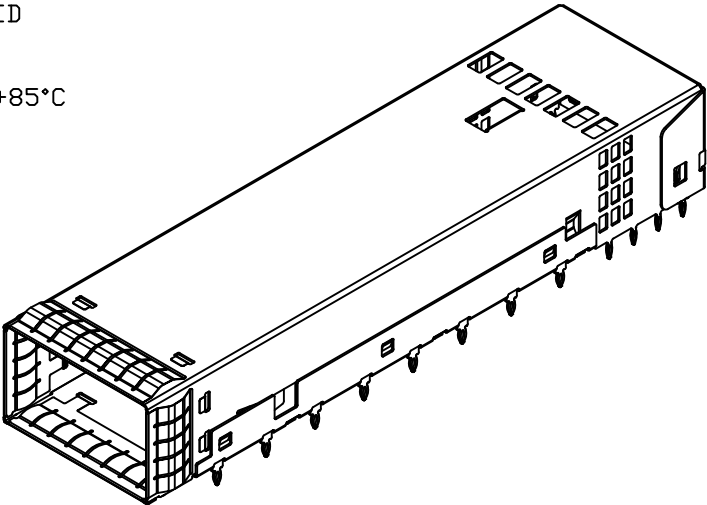




REV	DESCRIPTION OF CHANGE	REVIEWED BY	ISSUE DATE
A	FIRST ISSUE	X.YAN	2025-03-11

NOTES:

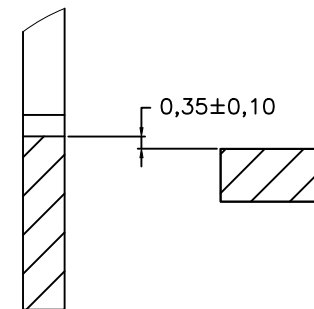
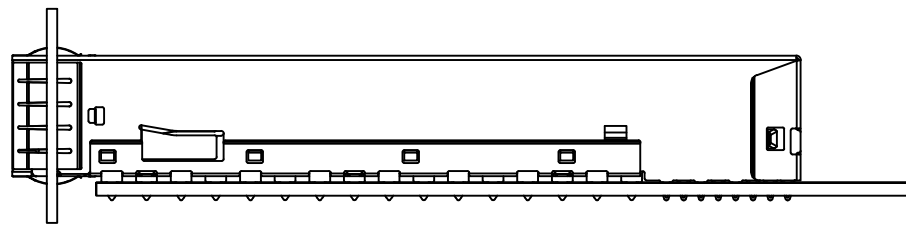
- 1.MATERIAL:
CAGE : STAINLESS STEEL,NI PLATED
- 2.PACKAGING: TRAY PACKAGING
- 3.TEMPERATURE RANGE: -55°C TO +85°C



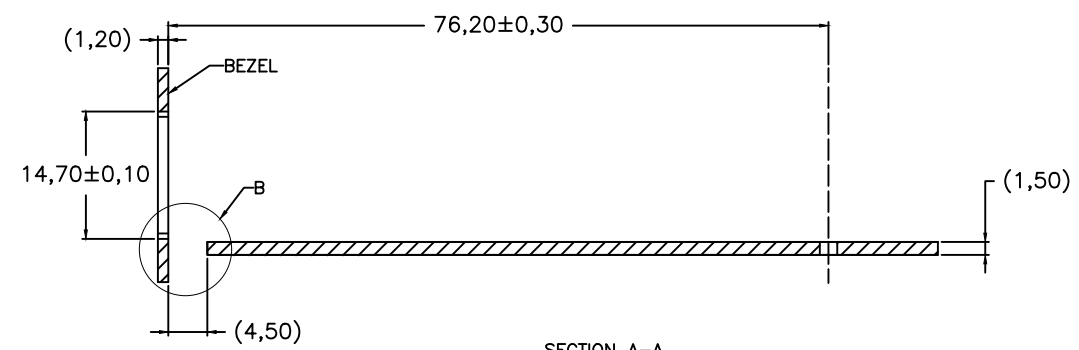
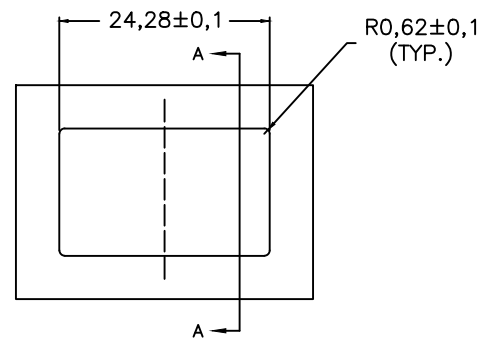
22,88±0,10
(PORT INTERNAL WIDTH,
WITH FULLY COMPRESSED
EMI FINGERS)

13,30±0,10
(PORT INTERNAL WIDTH,
WITH FULLY COMPRESSED
EMI FINGERS)

TITLE OSFP 1X1 CAGE			CND-tek 深圳磁联达电子有限公司 Shen zhen cnd-tek Electronics Co., Ltd	
PART NO. OSFP UE62-B1620-02121 1X1Y+			GENERAL TOLERANCE	UNIT:MM
APPROVE	CHECK	DRAW	.X±0.20	SIZE: A4
QG.CHEN	SL.WANG	X.YAN	.XX±0.15	SCALE: 1:1
			.XXX±0.10	
				SHEET:1/5
				REV:A

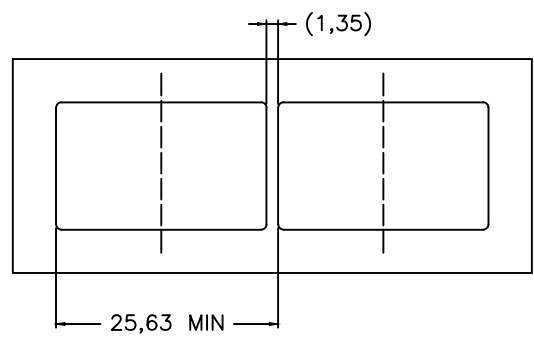


DETAIL B
SCALE 4:1

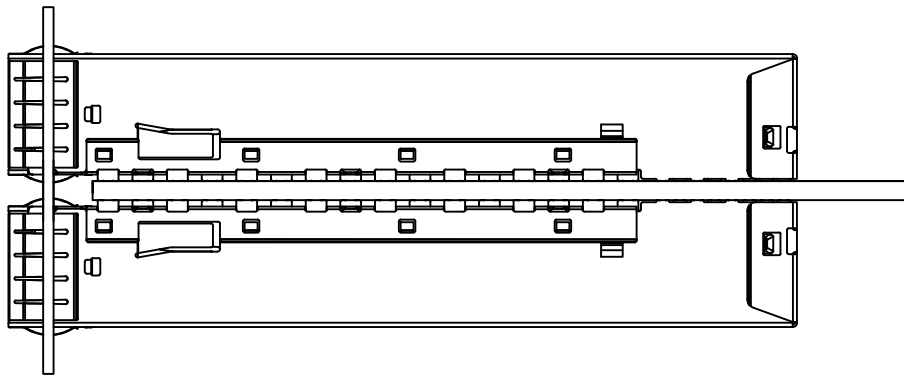


SECTION A-A
SCALE 2:1

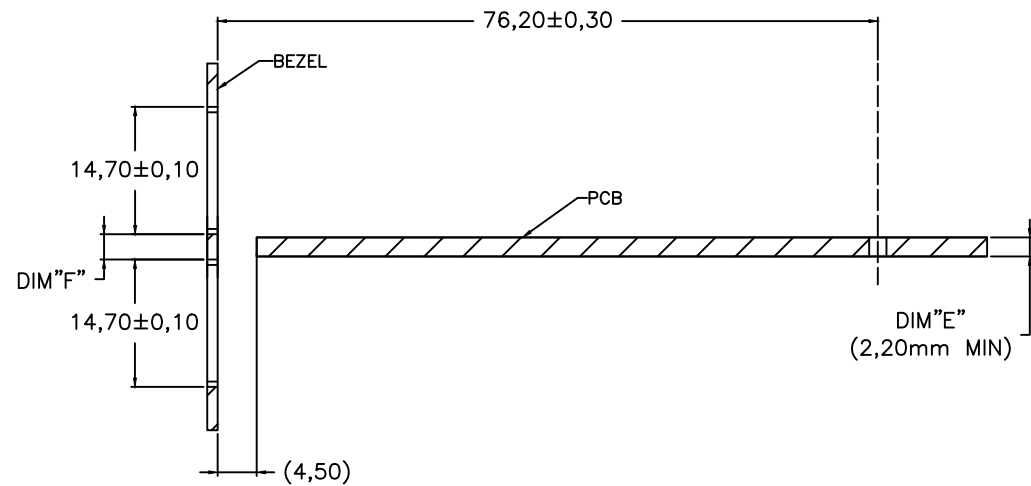
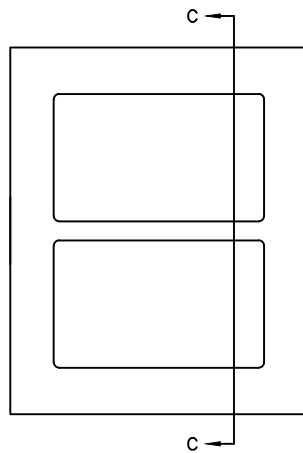
RECOMMENDED BEZE DESIGN
FOR SINGLE SAID MOUNTING



TITLE OSFP 1X1 CAGE			CND-tek 深圳磁联达电子有限公司 Shen zhen cnd-tek Electronics Co., Ltd			
PART NO. OSFP UE62-B1620-02121 1X1Y+			GENERAL TOLERANCE		UNIT:MM	SIZE: A4
APPROVE	CHECK	DRAW	.X±0.20	.X±1°	SCALE: 1:1	SHEET:4/5
QG.CHEN	SL.WANG	X.YAN	.XX±0.15	.XX±5°		
			.XXX±0.10			



NOTE:
PANEL CUTOUT SIZES PER OSFP MSA SPEC.
FOR BELLY TO BELLY MOUNTING, DIM "E" (PCB THICKNESS) IS 2.20 mm MIN.
DIM "F" RELATED TO DIM "E". FOR DIM "F" = DIM "E" + 0.70 mm.
THE PANEL CUTOUT 14.70 mm MIGHT BE INCREASED UP TO 15.10 mm IN ORDER TO ACCOMMODATE PCB TOLERANCE.



SECTION C-C
SCALE 2:1

RECOMMENDED BEZE DESIGN
(BELLY TO BELLY CAGE MOUNTING)

TITLE OSFP 1X1 CAGE			CND-tek 深圳磁联达电子有限公司 Shen zhen cnd-tek Electronics Co., Ltd			
PART NO. OSFP UE62-B1620-02121 1X1Y+			GENERAL TOLERANCE		UNIT:MM	SIZE: A4
APPROVE	CHECK	DRAW	.X±0.20	.X±1°	SCALE: 1:1	SHEET:5/5
QG.CHEN	SL.WANG	X.YAN	.XX±0.15	.XX±5°		
			.XXX±0.10			